

Docket No.: ST01-006

PATENT**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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| In re Application of: | Il Kwon Shim et al. | : | Confirmation No.: | 8095 |
| Serial No.: | 10/055,094 | : | Art Unit: | 2823 |
| Filed: | 1/23/2002 | : | Examiner: | Michelle Estrada |
| For: | HEAT SPREADER ANCHORING & GROUNDING METHOD & THERMALLY ENHANCED PBGA PACKAGE USING THE SAME | : | | |

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

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SUPPLEMENTAL RESPONSE /AMENDMENT

Madam:

The following Supplemental Amendment and Remarks are submitted in addition to the first response to the 7/23/03 Office Action submitted via facsimile on this same date.

After this introductory section, there are Amendments to the Specification and then Remarks, each starting on a separate page. The Amendments to the Specification correct typographical errors and clarify text. No new matter has been added.